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BGE787B

750 MHz, 29 dB gain push-pull amplifier Rev. 4 — 16 September 2011

Product data sheet

1. **Product profile**

1.1 General description

Hybrid high dynamic range amplifier module operating at a supply voltage of 24 V (DC) in a SOT115J package. The module consists of two cascaded stages both in cascode configuration.

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

1.2 Features and benefits

- Excellent linearity
- Extremely low noise
- High gain
- Excellent return loss properties

1.3 Applications

■ Single module line extender in CATV systems operating in the 40 MHz to 750 MHz frequency range.

1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Gp	power gain	f = 50 MHz	28.5	-	29.5	dB
		f = 750 MHz	29	-	-	dB
I _{tot}	total current consumption (DC)	$V_B = 24 V$	[1] -	-	340	mA

[1] The module normally operates at $V_B = 24 \text{ V}$, but is able to withstand supply transients up to 30 V.



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2. Pinning information

Table 2. Pinning

	9		
Pin	Description	Simplified outline	Symbol
1	input		
2	common	1 3 5 7 9	5
3	common		$\frac{1}{2}$ $\frac{9}{2}$
5	+V _B		2 3 7 8
7	common		sym095
8	common		,
9	output		

3. Ordering information

Table 3. Ordering information

Type number	Package				
	Name	Description	Version		
BGE787B	-	rectangular single-ended package; aluminium flange; 2 vertical mounting holes; $2 \times 6-32$ UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads	SOT115J		

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_B	supply voltage		-	25	V
Vi	RF input voltage		-	55	dBmV
T _{stg}	storage temperature		-40	+100	°C
T _{mb}	mounting base temperat	ure	-20	+100	°C

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5. Characteristics

Table 5. Characteristics

Bandwidth 40 MHz to 750 MHz; $V_B = 24$ V; $T_{case} = 30$ °C; $Z_S = Z_L = 75$ Ω ; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Gp	power gain	f = 50 MHz	28.5	-	29.5	dB
		f = 750 MHz	29	-	-	dB
SL	slope cable equivalent	f = 40 MHz to 750 MHz	0.2	-	2.2	dB
FL	flatness of frequency response	f = 40 MHz to 750 MHz	-	-	±0.45	dB
S ₁₁	input return losses	f = 40 MHz to 80 MHz	20	-	-	dB
		f = 80 MHz to 160 MHz	18.5	-	-	dB
		f = 160 MHz to 320 MHz	17	-	-	dB
		f = 320 MHz to 640 MHz	15.5	-	-	dB
		f = 640 MHz to 750 MHz	14	-	-	dB
S ₂₂	output return losses	f = 40 MHz to 80 MHz	20	-	-	dB
		f = 80 MHz to 160 MHz	18.5	-	-	dB
		f = 160 MHz to 320 MHz	17	-	-	dB
		f = 320 MHz to 640 MHz	15.5	-	-	dB
		f = 640 MHz to 750 MHz	14	-	-	dB
Ψs21	phase response	f = 50 MHz	135	-	225	deg
СТВ	composite triple beat	110 channels flat; $V_0 = 44 \text{ dBmV}$; measured at 745.25 MHz	-	-	-48	dB
X _{mod}	cross modulation	110 channels flat; V _o = 44 dBmV; measured at 55.25 MHz	-	-	-52	dB
CSO	composite second order distortion	110 channels flat; V _o = 44 dBmV; measured at 746.5 MHz	-	-	-56	dB
d_2	second order distortion		[1] -	-	-70	dB
Vo	output voltage	$d_{im} = -60 \text{ dB}$	[2] 59	-	-	dBmV
NF	noise figure	f = 50 MHz	-	-	5	dB
		f = 750 MHz	-	-	6.5	dB
PM	positive match	f = 40 MHz to 2 GHz	-	-	3	dB
I _{tot}	total current consumption (DC)		[3] _	-	340	mA

 $^{[1] \}quad f_p = 55.25 \text{ MHz}; \ V_p = 44 \text{ dBmV}; \ f_q = 691.25 \text{ MHz}; \ V_q = 44 \text{ dBmV}; \ measured \ at \ f_p + f_q = 746.5 \text{ MHz}.$

^[2] Measured according to DIN45004B; $f_p = 740.25 \text{ MHz}; \ V_p = V_o; \ f_q = 747.25 \text{ MHz}; \ V_q = V_o - 6 \text{ dB}; \ f_r = 749.25 \text{ MHz}; \ V_r = V_o - 6 \text{ dB}; \ measured at \ f_p + f_q - f_r = 738.25 \text{ MHz}.$

^[3] The module normally operates at $V_B = 24 \ V$, but is able to withstand supply transients up to 30 V.

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6. Package outline

Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads

SOT115J

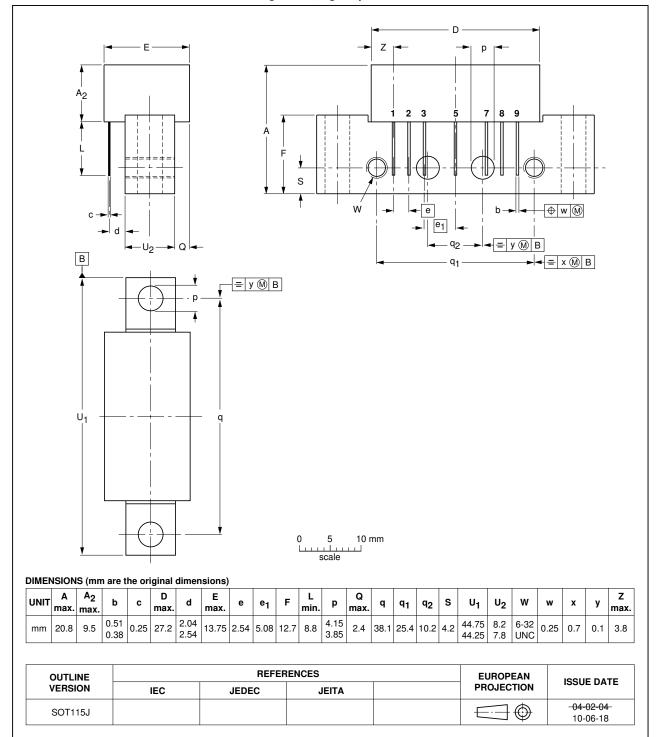


Fig 1. Package outline SOT115J

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7. Revision history

Table 6. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BGE787B v.4	20110916	Product data sheet	-	BGE787B v.3
Modifications:	guidelines of • Legal texts h	f this data sheet has been redened NXP Semiconductors. ave been adapted to the new of the drawings have been updated to the new of the drawings have been updated.	company name whe	re appropriate.
BGE787B v.3 (9397 750 14788)	20050329	Product data sheet	-	BGE787B_N v.2
BGE787B_N v.2 (9397 750 07565)	20001003	Preliminary specification	-	BGE787B v.1
BGE787B v.1 (9397 750 07011)	20000426	Objective specification	-	-

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8. Legal information

8.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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